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## FUSB1500 — USB2.0 Full-Speed / Low-Speed Transceiver with Charger Detection

## Features

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- Complies with USB2.0 Specification
- Supports 12Mbps and 1.5Mbps USB2.0 Speeds
  - Single Ended (SE) Mode Signaling
  - Slew-Rate Controlled Differential Data Driver
  - Differential Input Receiver with Wide Common-Mode Range and High Input Sensitivity
  - Stable RCV Output during SE0 Condition
  - Two Single-Ended Receivers with Hysteresis
- Supports I/O Voltage: 1.65V to 3.6V

## **Applications**

- Dual-Camera Applications for Cell Phones
- Dual-LCD Applications for Cell Phones, Digital Camera Displays, and Viewfinders

## Description

The FUSB1500 is a USB2.0 FS/LS transceiver with resistive charger detection. It is compliant with the Universal Serial Bus Specification, Rev. 2.0 (USB2.0).

Ideal for portable electronic devices; such as mobile phones, digital still cameras, and personal digital assistants; it allows USB Application Specific ICs (ASICs) and Programmable Logic Devices (PLDs) with power supply voltages from 1.65V to 3.6V to interface with the physical layer of the Universal Serial Bus.

The FUSB1500 can be used as a USB device transceiver or a USB host transceiver. It can transmit and receive serial data at both full-speed (12Mbps) and low-speed (1.5Mbps) data rates.

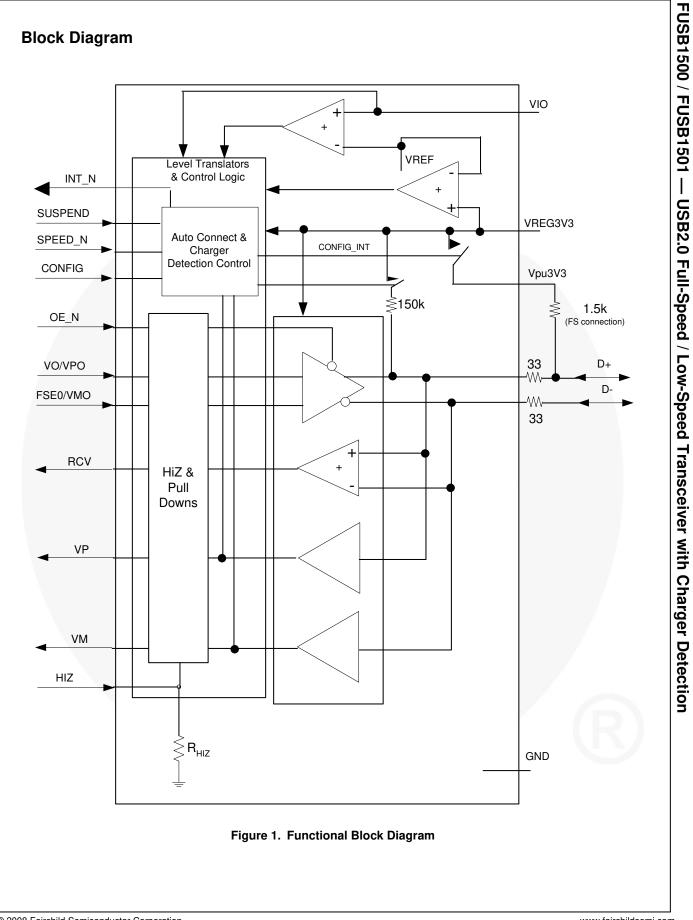
The FUSB1500 supports the SE Mode controller interface.

## **IMPORTANT NOTE:**

For additional performance information, please contact <u>analogswitch@fairchildsemi.com</u>.

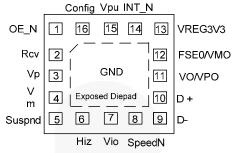
## **Ordering Information**

Part Number	Operating Temperature Range	Top Mark	Package	Packing Method
FUSB1500MHX	-40 to +85°C	FUSB 1500	16-Pin, Molded Leadless Package (MLP), JEDEC MO217 Equivalent, 3mm Square	Tape and Reel



FUSB1500 / FUSB1501 — USB2.0 Full-Speed / Low-Speed Transceiver with Charger Detection

**Pin Configuration** 





## **Pin Definitions**

Pin #	Name	I/O	Description
1	OE_N	I	Output enable. Active LOW enables the transceiver to transmit data on the bus. When not active, the transceiver is in the receive mode (CMOS level is relative to $V_{IO}$ ).
2	RCV	0	Receive data output. Non-inverted CMOS level output for USB differential input (CMOS output level is relative to $V_{IO}$ ). Driven LOW when SUSPND mode is active; (SUSPND is only enabled per the specific extended control table – <i>see Table 4</i> ); RCV output is stable and preserved during SE0 condition.
3	VP	0	Single-ended D+ receiver output VP (CMOS level relative to $V_{IO}$ ); used for external detection of SE0, error conditions, speed of connected device; driven HIGH when no supply connected to $V_{REG3V3}$ .
4	VM	0	Single-ended D- receiver output VM (CMOS level relative to $V_{IO}$ ); used for external detection of SE0, error conditions, speed of connected device; driven HIGH when no supply is connected to $V_{REG3V3}$ .
5	SUSPND	I	Suspend. Enables a low-power state (CMOS level is relative to $V_{IO}$ ). While the FUSB1500 is suspended, it drives the RCV pin to logic "0" state. (Suspend is only enabled per the specific extended control table – <i>see Table 4</i> ).
6	HiZ	I	High-Z input (CMOS level is relative to $V_{IO}$ ). HIGH selects the high-Z mode, which puts all the outputs, including VPU, in high impedance. There is a 100k $\Omega$ weak pull-down on this pin.
7	VIO		Supply voltage for digital I/O pins (1.65V to 3.6V). When not connected, the D+ and D- pins are in three-state. This supply bus is independent of VPU and VREG3V3.
8	SPEED_N	Т	Speed selection input (CMOS level relative to $V_{IO}$ ); adjusts the slew rate of differential outputs D+ and D- according to the extended control table (see Table 4).
9	D-	AI/O	Data- bus connection.
10	D+	AI/O	Data+ bus connection; for FS peripheral mode, connect to VPU via $1.5k\Omega$ .
11	VO/VPO	Ι	Driver data input (CMOS level is relative to $V_{IO}$ ); Schmitt-trigger input; VO is input pin for SE Mode.
12	FSE0/VMO	I	Driver data input (CMOS level is relative to $V_{IO}$ ); Schmitt-trigger input; FSE0 is input pir for SE Mode, see Table 2 and Table 3.
13	VREG3V3		Supply voltage input for 3.3V operation.
14	INT_N	0	This interrupt is active LOW. It is asserted when an SE0 is seen on the USB bus (SE0 detection circuit is only enabled per the specific extended control table). It is also referenced to $V_{IO}$ .
15	VPU		Pull-up supply voltage (3.3V $\pm$ 300mV); connect an external 1.5k $\Omega$ resistor on D+ (FS data rate) or D- (LS data rate). Internal switch is controlled by the CONFIG, SPEED_N, and SUSPND input pins ( <i>see Table 4</i> ).
16	CONFIG	Ι	USB connect or disconnect, software-control input. SPEED_N and SUSPND also gate the pull-up resistor ( <i>see Table 4</i> ).
Exposed Die Pad	GND	GND	GND supply bonded to exposed die pad to be connected to the PCB GND.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>IO</sub>	I/O Supply Voltage		-0.5	4.6	V
V <sub>PU</sub> , V <sub>REG3V3</sub>	Regulated Supply Voltage and Pull-up Supply		-0.5	4.6	V
I <sub>LU</sub>	Latch-up Current	$V_{IN} = -1.8$ to $+5.4V$		150	mA
I <sub>IK</sub>	DC Input Current	V <sub>IN</sub> < 0		-50	mA
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>		-0.5	V <sub>IO</sub> +0.5	V
Ι <sub>ΟΚ</sub>	DC Output Diode Current	$V_{OUT} > V_{REG3V3} \text{ or } < 0$		±50	mA
V <sub>OUT</sub>	DC Output Voltage <sup>(1)</sup>		-0.5	V <sub>IO</sub> +0.5	V
	DC Output Source or Sink Current for D+, D- Pins	$V_{OUT} = 0$ to $V_{REG3V3}$		±50	
I <sub>OUT</sub>	DC Output Source or Sink Current for RCV, VM/VP	$V_{OUT} = 0$ to $V_{REG3V3}$		±15	mA
I <sub>vreg3v3</sub> , I <sub>gnd</sub>	DC V <sub>VREG3V3</sub> or GND Current			±100	mA
		Pins D+, D-, $I_{LI} < 3\mu A$	-10500	+10500	
	Human Body Model, JEDEC: JESD22-A114	VREG3V3, VIO, and GND; I <sub>LI</sub> < 3μA;	-12000	+12000	
ESD		All Other Pins, $I_{LI} < 1\mu A$	-6500	+6500	
LOD	Machine Model, JESD22-A115			200	
	Charged Device Model, JEDEC: JESD-C101			+1500	
		Air Gap		+15000	
	IEC 61000-4-2	Contact		+8000	
T <sub>STG</sub>	Storage Temperature Range		-40	+125	°C
D	Dewer Dissignation	I <sub>CC(VREG3V3)</sub>		48	
P <sub>D</sub>	Power Dissipation	I <sub>CCIO</sub>		9	mW

#### Note:

1. Absolute maximum ratings for I/O must be observed.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>REG3V3</sub>	DC Supply Voltage		3.0	3.6	V
V <sub>IO</sub>	I/O DC Voltage		1.65	3.60	V
V <sub>IN</sub>	DC Input Voltage Range		0	V <sub>IO</sub>	V
V <sub>AI/O</sub>	DC Input Range for AI/Os	Pins D+ and D-	0	3.6	V
T <sub>A</sub>	Operating Ambient Temperature		-40	+85	°C

## **Electrical Characteristics — Supply Pins DC Characteristics**

Unless otherwise noted, values are over the recommended range of supply voltage and operating free air temperature.  $V_{REG3V3} = 3.0V$  to 3.6V and  $V_{IO} = 1.65V$  to 3.6V.

Oursela a l	Devenenter	Test Oanditions	T <sub>A</sub> =-4			
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>REG3V3</sub>	Regulated Supply Input <sup>(2,3)</sup>		3.0	3.3	3.6	V
I <sub>VREG3V3</sub>	Operating Supply Current (V <sub>REG3V3</sub> ) <sup>(4)</sup>	Transmitting and Receiving at 12Mbps; $C_{LOAD} = 50pF(D+, D-)$		4	8	mA
I <sub>CCIO</sub>	I/O Operating Supply Current <sup>(4)</sup>	Transmitting and Receiving at 12Mbps		1	2	mA
I <sub>IDLE</sub>	Supply Current During FS Idle and SE0 $(V_{REG3V3})^{(5)}$	$ \begin{array}{l} \text{IDLE: } V_{D_{+}} \geq 3.0V,  V_{D_{-}} \leq 0.3V; \\ \text{SE0: } V_{D_{+}} \leq 0.3V,  V_{D_{-}} \leq 0.3V \end{array} $			500	μA
I <sub>CCIO(STATIC)</sub>	I/O Static Supply Current	IDLE, SUSPND, or SE0			20	μA
I <sub>SUSPND</sub>	Suspend (V <sub>REG3V3</sub> ) Supply Current <sup>(5)</sup>	SUSPND = H; OE_N = H or L; D+ = D- = Not Floating; VM = VP = Open			25	μA
IDISABLE	Disable-Mode (V <sub>REG3V3</sub> ) Supply Current <sup>(5)</sup>	VIO Not Connected, D+ = D- = Not Floating			25	μA
ISHARING	I/O Sharing-Mode Supply Current	VREG3V3 Not Connected			20	μA
$I_{D\pm (SHARING)}$	Sharing-Mode Load Current on D+/D- Pins	VREG3V3 Not Connected, CONFIG = LOW, $V_{D\pm}$ = 3.6V			10	μA
V	V Throphold Detection Voltage	Supply Lost			0.5	v
$V_{REF}$	V <sub>IO</sub> Threshold-Detection Voltage	Supply Present	1.4			v
$V_{\rm IO\_hys}$	V <sub>IO</sub> Threshold-Detection Hysteresis Voltage <sup>(4)</sup>	$V_{\text{REG3V3}} = 3.3V$		450		mV

Notes:

2. I<sub>LOAD</sub> includes the pull-up resistor current via the VPU pin.

3. The minimum voltage in Suspend Mode is 2.7V.

4. Not tested in production; value based on characterization.

5. Excludes any current from load and  $V_{PU}$  or  $V_{SW}$  current to the 1.5k $\Omega$  and 15k $\Omega$  pull-up / pull-down resistors (200 $\mu$ A typical).

## **Electrical Characteristics — Digital Pins DC Characteristics**

Excludes D+ and D- pins. Unless otherwise noted, values are over the recommended range of supply voltage and operating free air temperature.  $V_{REG3V3} = 3.0V$  to 3.6V and  $V_{IO} = 1.65V$  to 3.6V.

0	Deveryotary	Teet Oenditiere	T <sub>A</sub> =-40°C			
Symbol	Parameter	Test Conditions	Min.	Max.	- Units	
Input Lev	els					
V <sub>IL</sub>	LOW-Level Input Voltage			0.3	V	
V <sub>IH</sub>	HIGH-Level Input Voltage		0.6 • V <sub>IO</sub>		V	
Output Le	evels					
		I <sub>OL</sub> = 2.0mA		0.4	V	
V <sub>OL</sub> LO	LOW-Level Output Voltage	I <sub>OL</sub> = 100μA		0.15	v	
	$I_{OH} = 2.0 \text{mA}$		V <sub>IO</sub> - 0.4			
V <sub>OH</sub>	HIGH-Level Output Voltage	I <sub>OH</sub> = 100μA	V <sub>IO</sub> - 0.15		V	
Leakage	Current					
ILI	Input Leakage Current, Excluding HIZ	V <sub>IO</sub> = 1.65 to 3.60V	-1	+1	μA	
Capacitar	nce					
$C_{IN,} C_{I/O}$	Input Capacitance <sup>(6)</sup>	Pin to GND		10	pF	
Resistanc	ce					
R <sub>HIZ</sub>	Pull-Down Resistance on HIZ Input Pin		100		kΩ	
R <sub>CHRGPU</sub>	Pull-Up Resistance for CHRGR Function		105	171	kΩ	

#### Note:

6. Not tested in production; value based on characterization.

## Electrical Characteristics — Analog I/O Pins DC Characteristics

Unless otherwise noted, values are over the recommended range of supply voltage and operating free air temperature.  $V_{REG3V3} = 3.0V$  to 3.6V and  $V_{IO} = 1.65V$  to 3.6V.

	<b>_</b>	<b>T</b> 10 IIII	T <sub>A</sub> =-40°C to 85°C			
Symbol	Parameter	Test Conditions	Min. Max.		- Units	
Input Lev	els – Differential Receiver		-	•		
V <sub>DI</sub>	Differential Input Sensitivity	V <sub>IN(D+)</sub> - V <sub>IN(D-)</sub>	0.2		V	
V <sub>CM</sub>	Differential Common Mode Voltage		0.8	2.5	V	
Input Lev	els – Single-Ended Receiver					
V <sub>IL</sub>	LOW-Level Input Voltage			0.8	V	
V <sub>IH</sub>	HIGH-Level Input Voltage		2.0		V	
$V_{\text{HYS}}$	Hysteresis Voltage <sup>(7)</sup>		0.4	0.7	V	
Output Le	evels					
V <sub>OL</sub>	LOW-Level Output Voltage	$R_L = 1.5 k\Omega$ to 3.6V		0.3	V	
V <sub>OH</sub>	HIGH-Level Output Voltage <sup>(8)</sup>	$R_L = 15k\Omega$ to GND	2.8	3.6	V	
Leakage	Current					
I <sub>OFF</sub>	Input Leakage Current – Off State		-1	+1	μA	
Capacitar	nce					
CI/O	I/O Capacitance <sup>(7)</sup>	Pin to GND		20	pF	
Resistanc	ce de la constante					
Z <sub>DRV</sub>	Driver Output Impedance <sup>(9)</sup>	Steady State	34	44	Ω	
Z <sub>IN</sub>	Driver Input Impedance		10		MΩ	
R <sub>sw</sub>	Switch Resistance	$I_{SW} = 0$ to 10mA		15	Ω	
V <sub>TERM</sub>	Termination Voltage <sup>(10,11)</sup>	R <sub>PU</sub> - Upstream Port	3.0	3.6	V	

Notes:

7. Not tested in production; value based on characterization.

8.  $V_{OH}$  minimum =  $V_{REG3V3} - 0.2V$ .

9. Includes external  $33\Omega \pm 1\%$  on both D+ and D- pins to comply with USB2.0.

10. This voltage is available at the VPU and VREG3V3 pins.

11. Minimum voltage is 2.7V in Suspend Mode.

## Electrical Characteristics — AI/O Pins AC Characteristics, Full Speed

Unless otherwise noted, values are over the recommended range of supply voltage and operating free air temperature.  $V_{REG3V3}$  = 3.0V to 3.6V and  $V_{IO}$ = 1.65V to 3.6V.

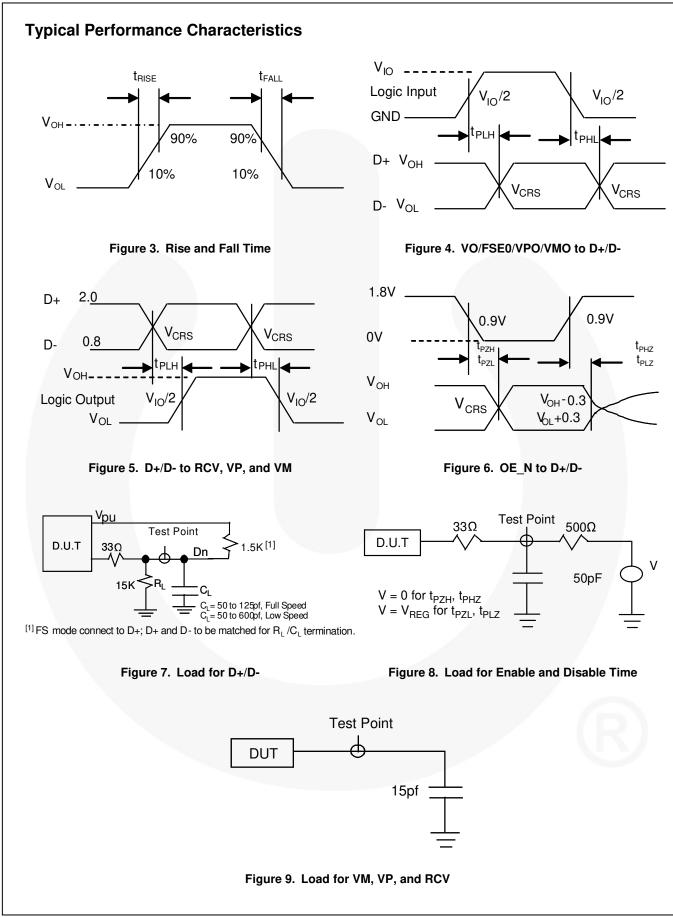
Symbol	Paramatar	Test Conditions	T <sub>A</sub> =	5°C	Units	
Symbol	Parameter	Test Conditions	Min.	Typ. <sup>(13)</sup>	Max.	
Driver C	haracteristics, FS Mode					
t <sub>FR</sub>	FS Output Rise Time <sup>(13,14)</sup>	10% to 90% $ V_{OH} - V_{OL} $ ; C <sub>L</sub> = 50 pF; <i>Figure 3</i>	4		20	ns
t <sub>FF</sub>	FS Output Fall Time <sup>(13,14)</sup>	90% to 10%  V <sub>OH</sub> - V <sub>OL</sub>  ; C <sub>L</sub> = 50 pF; <i>Figure 3</i>	4		20	
t <sub>FRFM</sub>	FS Rise/Fall Time Match <sup>(13,14)</sup>	t <sub>R</sub> /t <sub>F</sub> Excludes First Transition from Idle State	90.0		111.1	%
V <sub>CRS</sub>	Output Signal Crossover Voltage <sup>(13,14)</sup>	Excludes First Transition from Idle State	1.3	V <sub>REG3V3</sub> /2 ±200mV	2.0	V
Driver C	haracteristics, LS Mode					
t <sub>LR</sub>	LS Output Rise Time <sup>(13,14)</sup>	10% to 90% $ V_{OH} - V_{OL} $ ; C <sub>L</sub> = 50 to 600pF; <i>Figure 3</i>	75		300	ns
t <sub>LF</sub>	LS Output Fall Time <sup>(13,14)</sup>	90% to 10%  V <sub>OH</sub> - V <sub>OL</sub>  ; C <sub>L</sub> = 50 to 600pF; <i>Figure 3</i>	75		300	
t <sub>LRFM</sub>	LS Rise/Fall Time Match <sup>(13,14)</sup>	t <sub>R</sub> /t <sub>F</sub> Excludes First Transition from Idle State	80		125	%
V <sub>CRS</sub>	Output Signal Crossover Voltage <sup>(13,14)</sup>	Excludes First Transition from Idle State	1.3		2.0	v
Driver T	iming, FS Mode					
t <sub>PLH</sub>	Propagation Delay,	Input Edge Rates = 2.5ns;			20	ns
t <sub>PHL</sub>	FSE0/VO/VPO/ VMO to D+/D-	Figure 4			20	ns
t <sub>PHZ</sub>	Driver Disable Delay, OE_N to D+/D-	Figure 6 , Figure 8			18	ns
t <sub>PLZ</sub>					18	ns
t <sub>PZH</sub>	Driver Enable Delay, OE_N to D+/D-	Figure 6 , Figure 8			18	ns
t <sub>PZL</sub>	(10.12)				18	ns
	iming, LS Mode <sup>(12,13)</sup>					
Receive	r Timing, FS and LS Mode		1			
t <sub>PLH</sub>	Differential Receiver Propagation	$C_L = 15 pF$ , <i>Figure 5, Figure 9</i>			21	ns
t <sub>PHL</sub>	Delay, D+/D- to R <sub>CV</sub> <sup>(15)</sup>				21	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Single-Ended Receiver Propagation Delay, D+/D- to VP, VM	$C_L = 15 pF$ , <i>Figure 5, Figure 9</i>			18 18	ns ns
SE0 Det	ection Timing <sup>(13)</sup>					
t <sub>PWSE0</sub>	SE0 Pulse Width Detection for INT_N <sup>(13)</sup>	Suspend, Config,Speed_N=011 VIO=VREG3V3= 3.6V		260		ns

13. Not production tested; guaranteed by characterization.

14. Typical conditions are at 25°C and 3.3V.

15. Excludes exiting Suspend or HiZ Mode.





## **Functional Description**

The FUSB1500 transceiver is designed to convert CMOS data into USB differential bus signal levels and to convert USB differential bus signals to CMOS data. The FUSB1500 supports the SE Mode interface from the controller and has an extended Control Mode that enables a simplified dedicated charger functionality via a weak pull-up resistance (nominally  $125k\Omega$ ). This mode is described in Table 4.

To minimize EMI and noise, the outputs are edge-rate controlled with the rise and fall times defined for full-speed (12Mbps) and low-speed (1.5Mbps) data rates. The rise and fall times are balanced between the differential pins to minimize skew.

The FUSB1500 is defined as a self-powered device, or bus-powered where the regulation down to 3.3V is external to the FUSB1500, so it accepts the regulated 3.3V as its supply input. The  $V_{IO}$  rail supports I/Os of 1.65V to 3.6V.

If  $V_{\rm IO}$  is lost, the pins go into the high-Z state. If  $V_{\rm IO}$  is present, but the  $V_{\rm REG3V3}$  power supply is lost, the high-Z detection circuit still functions.

#### **USB Mode**

Table 1 describes the specific pin functionality when USB Traffic Mode is selected. This is also referred to as normal mode. Table 2 and Table 3 describe the specific truth tables for driver and receiver operating functions.

#### Table 1. Function Table for USB Mode

OE_N	Hi-Z	D+, D-	RCV	VP/VM	Function
LOW	LOW	Driving & Receiving	Active	Active	Normal Driving (Differential Receiver Active)
HIGH	LOW	Receiving <sup>(16)</sup>	Active	Active	Receiving
LOW	LOW	Driving	Inactive <sup>(17)</sup>	Active <sup>(18)</sup>	Driving during Suspend (Differential Receiver Inactive)

#### Notes:

16. Signal levels on the D+ and D- pins are determined by external connections and Table 4 (Extended Control Configurations).

17. When in Suspend Mode (see Table 4 for suspended configurations), the differential receiver is inactive and the RCV output is forced LOW. Out-of-suspend signaling (K) is detected via the single-ended receiver outputs VP and VM.

18. The states of VP and VM are functions of signal levels on D+/D- in normal mode.

#### Table 2. Driver Function (OE\_N = L, HiZ= L or Floating ) USB Transmit Mode

50504/000	NONDO	FUSB1500
FSE0/VMO	VO/VPO	Data (D+, D-)
LOW	LOW	Differential Logic 0 (01)
LOW	HIGH	Differential Logic 1 (10)
HIGH	LOW	SE0 <sup>(19)</sup> (00)
HIGH	HIGH	SE0 <sup>(19)</sup> (00)

Note:

19. SE0 – Single-Ended Zero.

#### Table 3. Receiver Function (OE\_N = H, HiZ= L or Floating ) USB Receive Mode

D+, D-	RCV	<b>VP</b> <sup>(20)</sup>	<b>VM</b> <sup>(20)</sup>
Differential Logic 1	HIGH	HIGH	LOW
Differential Logic 0	LOW	LOW	HIGH
SE0	RCV <sup>(21)</sup>	LOW	LOW
X-(Sharing Mode) <sup>(22)</sup>	LOW	HIGH	HIGH

#### Note:

20. VP = VM = HIGH indicates Sharing Mode.

21. Denotes the signal level on output RCV prior to the SE0 event. This level is stable during the SE0 event period.

22. Sharing mode is not a function of D+/D- but is entered when  $V_{IO}$  is present and  $V_{REG3V3}$  is disconnected.

## Functional Description (Continued)

### Extended Control Mode

This block of control has a multi-function role; it is used to signal a SE0 detect to the host via INT\_N and uses a weak resistor pull-up method for charger detection.

Note that the signaling of SE0 via INT\_N is only enabled for the state "011" and all SE0 events can still be decoded from the VP, VM, and RCV outputs.

When the three inputs (SUSPND, CONFIG, and SPEED\_N) are not "011," INT\_N is not active; the SE0 detector (RCV = 0) is not active and its latch is set to HIGH. When the "011" is seen on the inputs, the FUSB1500/1501 is waiting for an SE0 event. When the SE0 event (deglitched) is detected, INT\_N goes active

(HL transition). The host detects this INT\_N signal and configures the inputs to the pattern "110" or "010" to keep the  $1.5 \mathrm{k}\Omega$  pull-up enabled. The INT\_N signal is then de-asserted and the SE0 detector reset.

If a code other than "010" or "110" is written, the mode configuration is a function as described in Table 4 and the SE0 detector and INT\_N are de-asserted to reset states.

When entering the state "111," which enables the weak pull up resistor for charger detection, the D+/D- drivers are automatically configured to USB receive mode (equivalent to OE\_N HIGH).

Figure 10 shows the extended control logic and Table 4 the truth table for the extended control.

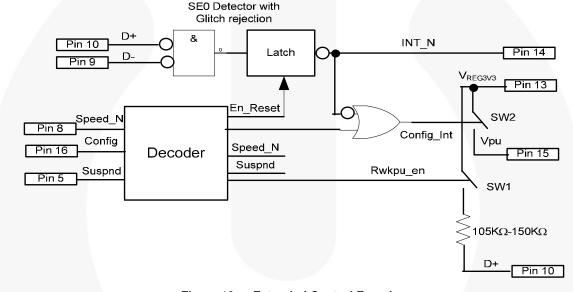


Figure 10. Extended Control Function

#### Table 4. Extended Control

Hi-Z	SUSPND	CONFIG	SPEED_N	Function			
0	0	0	0	No 1.5kΩ Pull-up	FS	USB Mode, Default State	
0	0	1	0	1.5kΩ Pull-up	FS	USB Mode	
0	0	0	1	No 1.5kΩ Pull-up	LS	USB Mode	
0	0	1	1	Pull-up On After Detecting SE0	FS	Suspend, Conditional Pull-up	
0	1	0	0	No 1.5kΩ Pull-up	FS	Suspend	
0	1	1	0	1.5kΩ Pull-up	FS	Suspend	
0	1	0	1	No 1.5kΩ Pull-up	LS	Suspend	
0	1	1	1	No 1.5k $\Omega$ Pull-up, 125k $\Omega$ Pull-up Connected		USB Rx Mode & RWPU On	
1	х	х	Х	VP, VM, D+, D-, RCV High Impedance, SW1 and SW2 Open		Hi-Z Mode	

## Functional Description (Continued)

#### **Power Supply Configurations and Options**

The three modes of power-supply operation are:

- Normal Mode The VIO and VREG3V3 pins are connected. V<sub>IO</sub> is an independent voltage source (1.65 to 3.6V) that is a function of the external circuit configuration.
- Disable Mode VIO is not connected; VREG3V3 is connected. In this mode, the D+, D- pins are threestate and the device enters low-power (suspended) state upon detection of V<sub>IO</sub> lost.
- Hi-Z Mode When the Hi-Z pin is pulled HIGH, with VREG3V3 powered, the RCV/VP/VM interface can be used to access the Baseband for production test programming. VP/VM/RCV are in high impedance states.
- Sharing Mode  $V_{IO}$  is the only supply connected. In this mode, the D+ and D- pins are three-state and the FUSB1500 allows external signals up to 3.6V to share the D+ and D- bus lines. Internally, the circuitry limits leakage from the D+ and D- pins (maximum 10µA) and V<sub>IO</sub> such that device is in lowpower (suspended) state. The VP and VM pins are driven HIGH and RCV is forced LOW as an indication of this mode. Can be used for production test programming via D+/D-. to UART or Baseband processor. HiZ is to be Low or Floating to ensure VP/VM/RCV is signaled to processor.

A summary of the supply configurations is described in Table 5.

Pin	Hi-Z	Sharing	Disable	Normal
VREG3V3	3.3V Externally Supplied	Not Connected	Connected	3.3V Externally Supplied
VIO	1.65 - 3.6V Source	1.65-3.60V Source	Not Connected	1.65V- 3.60V Source
VPU	Three-State (Off)	Three-State (Off)	Three-State (Off)	Function of Mode Set-up
D+, D-	Three-State	Three-State	Three-State	Function of Mode Set-up
VP / VM	Three-State	HIGH	Invalid <sup>(23)</sup>	Function of Mode Set-up
RCV	Three-State LOW Invalid <sup>(23)</sup> Function c		Function of Mode Set-up	
VPO, VMO, SPEED_N,OE_N, SUSPND, CONFIG	Inputs	Inputs	Three-State	Function of Mode Set-up
HiZ	HIGH	LOW or Floating	Three-State	LOW or Floating
INT_N	HIGH	HIGH	Three-State	Function of Mode Set-up

#### **Table 5. Power Supply Mode Configuration Options**

#### Note:

23. Three-state or driven LOW.

#### Single Ended Zero Detection Timing

The SE0 detection logic is activated when entering the state "011" (SUSPND, CONFIG, and SPEED\_N) and the logic waits to detect an SE0 event. Since the FUSB1500 can also be used as an LS host device, it is important to ensure that the  $t_{LST}$  time for the USB2.0 specification is met.  $t_{LST}$  is the minimum time to not interpret LS differential signaling as an SE0 and is 210ns in duration. Similarly for FS differential signaling, there is a time period,  $t_{EST}$  time, of 14ns.

Seeing an SE0 for greater than  $t_{LST}$  results in the INT\_N pin toggling LOW. The FUSB1500 is designed for 260ns (typical).

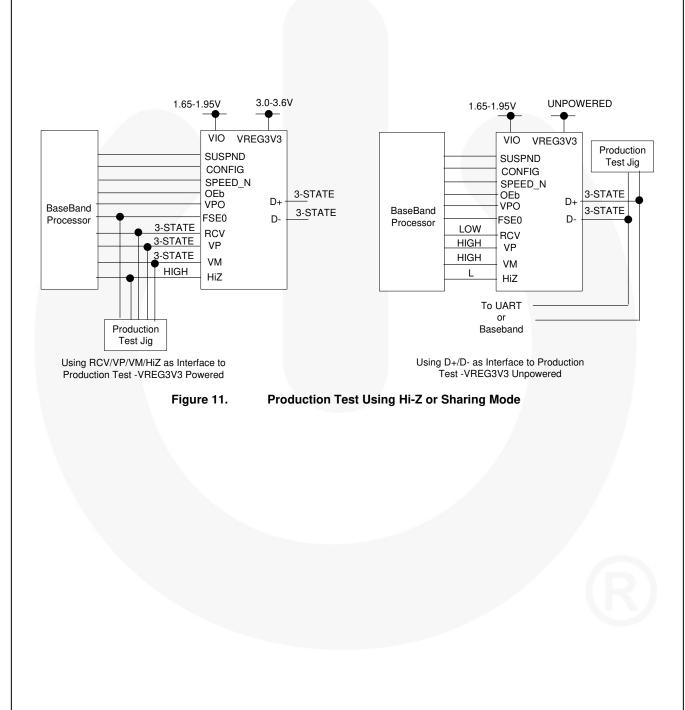
## **Exiting HiZ or Suspend Mode Timing**

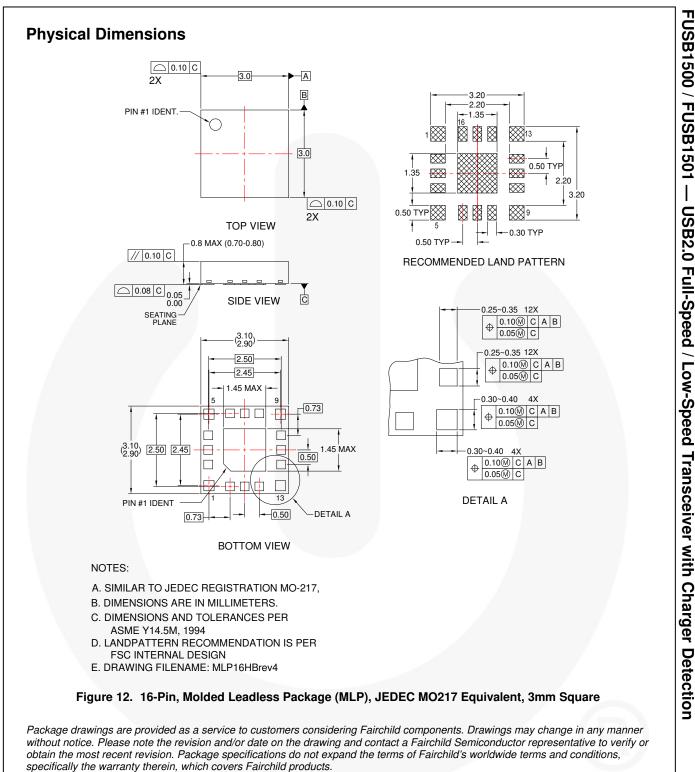
As the RCV path is required to maintain the previous state through an SE0 event, there is the possibility when exiting HiZ or Suspend Mode to have the previous result stored. The transition through the SE0 decode logic is such that software should ignore RCV for at least 100ns when exiting HiZ mode to ensure the correct D+/D- state is available on the RCV output.

### **Hi-Z and Sharing Mode for Production Test**

When in production test, to gain access to the processor or UART, the D+/D- pins can be used (Sharing Mode) or the RCV/VP/VM interface of the host side of the FUSB1500 (Hi-Z). If sharing the D+/D- pins then VREG3V3 is unpowered and the processor is signaled this mode via the VP/VM outputs being pulled High and the RCV pin is pulled Low. If the RCV/VP/VM interface is to be used by production test then Hi-Z is pulled High, with VREG3V3 remaining powered.

Figure 11 indicates the production test scenarios.

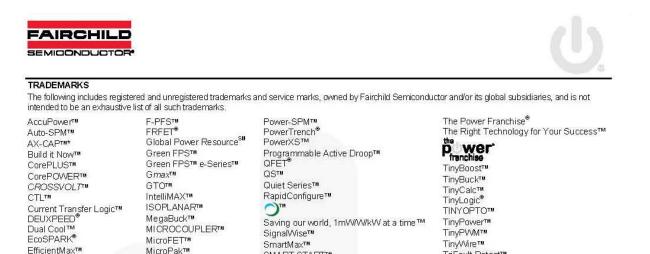




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